

Data sheet acquired from Harris Semiconductor SCHS065C – Revised November 2004

CD4098B Types

CMOS Dual Monostable Multivibrator

High-Voltage Types (20-Volt Rating)

■ CD4098B dual monostable multivibrator provides stable retriggerable/resettable one-shot operation for any fixed-voltage timing application.

An external resistor (Rx) and an external capacitor (CX) control the timing for the circuit. Adjustment of RX and CX provides a wide range of output pulse widths from the Q and Q terminals. The time delay from trigger input to output transition (trigger propagation delay) and the time delay from reset input to output transition (reset propagation delay) are independent of Rx and CX.

Leading-edge-triggering (+TR) and trailing-edge-triggering (-TR) inputs are provided for triggering from either edge of an input pulse. An unused +TR input should be tied to VSS. An unused -TR input should be tied to VDD. A RESET (on low level) is provided for immediate termination of the output pulse or to prevent output pulses when power is turned on. An unused RESET input should be tied to VDD. However, if an entire section of the CD4098B is not used, its RESET should be tied to VSS. See Table I.

In normal operation the circuit triggers (extends the output pulse one period) on the application of each new trigger pulse. For operation in the non-retriggerable mode, Q is connected to -TR when leading-edge triggering (+TR) is used or Q is connected to +TR when trailing-edge triggering (-TR) is used.

The time period (T) for this multivibrator can be approximated by: $T_X=\frac{1}{2}R_XC_X$ for $C_X \ge$ 0.01 µF. Time periods as a function of Rx for values of CX and VDD are given in Fig. 8. Values of T vary from unit to unit and as a function of voltage, temperature, and RXCX.

The minimum value of external resistance, R_X , is 5 k Ω . The maximum value of external capacitance, C_X , is 100 μF . Fig. 9 shows time periods as a function of C_X for values of R_X and VDD.

The output pulse width has variations of ±2.5% typically, over the temperature range of -55°C to 125°C for Cx=1000 pF and $R_X=100 k\Omega$.

For power supply variations of ±5%, the output pulse width has variations of ±0.5% typically, for VDD=10 V and 15 V and ±1% typically, for VDD=5 V at Cx=1000 pF and $R_X=5 k\Omega$.

These types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix). 16-lead small-outline packages (M, M96, and MT suffixes), and 16-lead thin shrink smalloutline packages (PW and PWR suffixes).

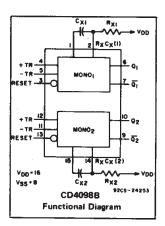
The CD4098B is similar to type MC14528.

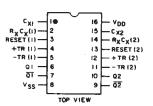
Features:

- Retriggerable/resettable capability
- Trigger and reset propagation delays independent of R_X, C_X
- Triggering from leading or trailing edge
- Q and Q buffered outputs available
- Separate resets
- Wide range of output-pulse widths
- 100% tested for maximum quiescent current at 20 V
- Maximum input current of 1 µA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range): 1 V at V_{DD}= 5 V 2 V at V_{DD}=10 V 2.5 V at V_{DD}=15 V 5-V, 10-V, and 15-V parametric ratings
- Standardized, symmetrical output characteristics
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices."

Applications:

- Pulse delay and timing
- Pulse shaping
- Astable multivibrator





TERMINALS 1,8,15 ARE ELECTRICALLY CONNECTED INTERNALLY

92CS-24848RI

TERMINAL ASSIGNMENT

MAXIMUM RATINGS, Absolute-Maximum Values:

	DC SUPPLY-VOLIAGE RANGE, (VE
0.5V to +20V	Voltages referenced to V _{SS} Termina
	INPUT VOLTAGE RANGE, ALL INPUT
±10mA	
(P _D):	POWER DISSIPATION PER PACKAG
	For $T_A = -55^{\circ}C$ to $+100^{\circ}C$
Derate Linearity at 12mW/°C to 200mW	For $T_A = +100^{\circ}C$ to $+125^{\circ}C$
	DEVICE DISSIPATION PER OUTPUT
ATURE RANGE (All Package Types)	FOR TA = FULL PACKAGE-TEMPS
T _A)55°C to +125°C	OPERATING-TEMPERATURE RANG
a)65°C to +150°C	STORAGE TEMPERATURE RANGE (
	LEAD TEMPERATURE (DURING SO
.79mm) from case for 10s max +265°C	At distance 1/16 ± 1/32 inch (1.59 :

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	V _{DD}	LIN			
CHARACTERISTIC	V	MIN	MAX.	UNITS	
Supply-Voltage Range (For TA = Full Package-Temperature Range)	_	3	18	V	
Trigger Pulse Width t _W (TR)	5 10 15	140 60 40	-	ns	
Reset Pulse Width tw(R) (This is a function of C _X)		See Dynamic Char. Chart and Fig. 10		_	
Trigger Rise or Fall Time t _r (TR), t _f (TR)	5 - 15	-	100	μs	

CD4098B Types

TABLE I
CD4098B FUNCTIONAL TERMINAL CONNECTIONS

FUNCTION	V _{DD} TO TERM. NO.		V _{SS} TO TERM. NO.		INPUT PULSE TO TERM. NO.		OTHER CONNECTIONS	
	MONO ₁	MONO ₂	MONO ₁	MONO ₂	MONO ₁	MONO ₂	MONO ₁	MONO ₂
Leading-Edge Trigger/ Retriggerable	3, 5	11, 13			4	12		
Leading-Edge Trigger/ Non-retriggerable	3	13			4	12	5-7	11.9
Trailing-Edge Trigger/ Retriggerable	3	13	4	12	5	11		
Trailing-Edge Trigger/ Non-retriggerable	3	13			5	11	4-6	12-10
Unused Section	5	11	3, 4	12, 13				

NOTES:

- 1. A RETRIGGERABLE ONE SHOT MULTI-VIBRATOR HAS AN OUTPUT PULSE WIDTH WHICH IS EXTENDED ONE FULL TIME PERIOD (T_X) AFTER APPLICATION OF THE LAST TRIGGER PULSE.
 - The minimum time between retriggering edges (or trigger and retrigger edges) is 40 per cent of (T_X).
- 2. A NON-RETRIGGERABLE ONE-SHOT MULTIVIBRATOR HAS A TIME PERIOD TX REFERENCED FROM THE APPLICATION OF THE FIRST TRIGGER PULSE.

INPUT PULSE TRAIN

RETRIGGERABLE MODE PULSE WIDTH

(+TR MODE)

NON-RETRIGGERABLE MODE PULSE

WIDTH

(+TR MODE)

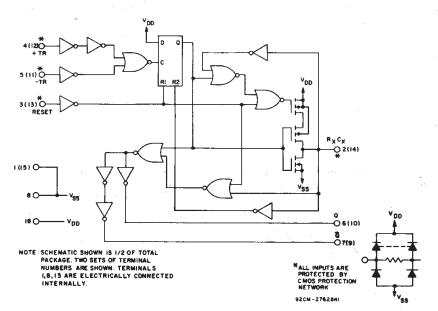


Fig. 4 — CD4098B logic diagram.

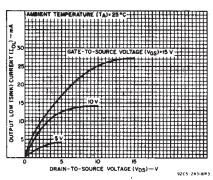


Fig. 1 — Typical output low (sink) current characteristics.

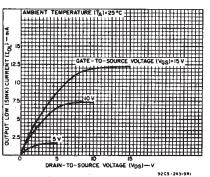


Fig. 2 — Minimum output low (sink) current characteristics.

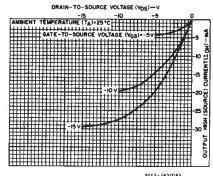


Fig. 3 — Typical output high (source) current characteristics.

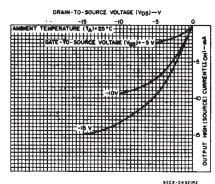


Fig. 5 - Minimum output high (source) current characteristics.

Copyright © 2004, Texas Instruments Incorporated

CD4098B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARAC-	CON	CONDITIONS LIMITS AT INDICATED TEMPERATURES (°C)									
TERISTIC	v _{o.}	VIN	V _{DD}					1	+25	٥,	UNITS
	(V)	(V)	(V)	-55	–40	+85	+125	Min.	Тур.	Max.	i Brah
Quiescent		0,5	5	- 1	1	30	30	_	0.02	1	
Device		0,10	10	2	2	60	60	=	0.02	2	1 .
Current		0,15	15	4	4	120	120	-	0.02	4	μА
IDD Max.		0,20	20	20	20	600	600	-	0.04	20	
Output Low			<u> </u>	_		:		 	<u> </u>	+	
(Sink)	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1		
Current,	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	 	
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	 	:
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36		-1	 	mA
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2		
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6		
I _{OH} Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-	
Output Volt-								<u> </u>	 	1	
age:	L -	0,5	5		0.0)5		_	0	0.05	
Low-Level,	_	0,10	10		0.0)5			0	0.05	
VOL Max.	_	0,15	15		0.0)5			0	0.05	
Output Volt-			,			·			 	-	V
age:		0,5	5		4.9	95		4.95	5	<u> </u>	
High-Level,	_	0,10	10	-	9.9			9.95	10		
VOH Min.	_	0,15	15		14.	95		14.95	.15	_	
Input Low	0.5,4.5		5		1.				_	1.5	
Voltage,	1,9	_	10		3				_	3	i
VIL Max.	1.5,13.5	-	15		4			_	_	4	
Input High	out High 0.5,4.5 - 5		٠.	3.5			3.5	_		V	
Voltage,	1,9	_	10	7 11				7			
V _{IH} Min.	1.5,13.5	1	15					11	_	_	
Input Current, I _{IN} Max.	:-	0,18	18	±0.1	±0.1	±1	±1	_	±10 ⁻⁵	±0.1	μΑ

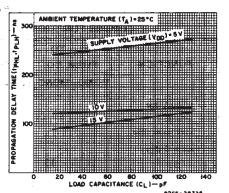


Fig. 6 - Typical propagation delay time vs.
load capacitance, trigger into Q
out. (All values of C_X and R_X.)

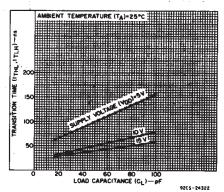


Fig. 7 – Transition time vs. load capacitance for R_X = 5 k Ω -10000 k Ω and C_X = 15 pF-10000 pF.

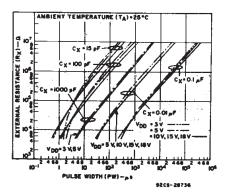


Fig. 8 — Typical external resistance vs. pulse width.

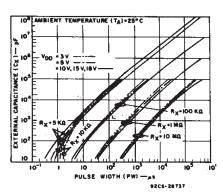


Fig. 9 – Typical external capacitance vs. pulse width.

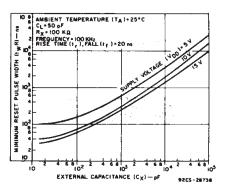


Fig. 10 — Typical minimum reset pulse width vs. external capacitance.

DYNAMIC ELECTRICAL CHARACTERISTICS

At $T_A = 25^{\circ}C$; Input $t_r, t_f = 20$ ns, $C_L = 50$ pF, $R_L = 200$ k Ω

CHARACTERISTIC	TEST	CONDITI	LIM			
CHARACTERISTIC	R _X (kΩ)	C _X (pF)	V _{DD} (V)	Тур.	Max.	UNITS
Trigger Propagation Delay Time	5 to		5	250	500	
+TR, $-$ TR to Q, $\overline{\mathbf{Q}}$	10,000	≥15	10	125	250	ns
tPHL, tPLH	10,000		15	100	200	
Minimum Trigger Pulse Width,	5 to		5	70	140	
• • • • • • • • • • • • • • • • • • •	10,000	≥15	10	30	60	ns
twh, twl	10,000		15	20	40	
Transition Time,	5 to		- 5	100	200	
^t TLH	10,000	≥15	10	50	100	
	10,000		15	40	80	
•	5 to	15 to	5	100	200	
	10,000	10,000	10	50	100	
	10,000	10,000	15	40	80	
	5 to	0.01 μF	5	150	300	ns
^t THL	10,000	to	10	75	150	
	10,000	0.1 μF	15	65	130	
	5 to	0.1 μF	5	250	500	
	10,000	to	10	150	300	
	10,000	1 μF	15	80	160	
Reset Propagation Delay Time,	5 to		5	225	450	1
Ta Ta	10,000	≥15	10	125	250	ns
T _{PHL} , T _{PLH}	10,000		15	75	150	
			5	100	200	
		15	10	40	80	
			15	30	60	
Minimum Reset Pulse Width,			5	600	1200	ns
twR	100	1000	10	300	600	
W			15	250	500	
			5	25	50	
		0.1 μF	10	15	30	μs
			15	10	20	
Trigger Rise or Fall Time			5 to			
$t_{r}(TR), t_{f}(TR)$	-	1 To 1	15	-, -,	100	μς
Pulse Width Match		, ,	5	5	10	
Between Circuits in	10	10,000	10	7.5	15	- %
Same Package			15	7.5	15	
Input Capacitance, CIN		Any Input		5	7.5	ρF

TEST CIRCUITS

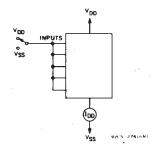


Fig. 12 — Quiescent-device-current test circuits.

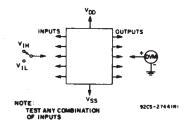


Fig. 13 - Input-voltage test circuit.

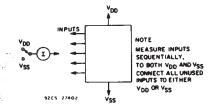


Fig. 14 — Input leakage current test circuit.

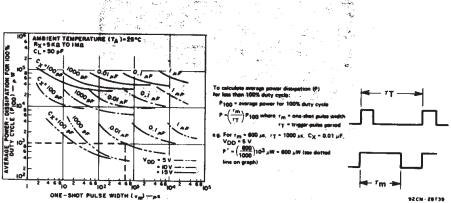


Fig. 11 - Average power dissipation vs. one-shot pulse width.

CD4098B Types

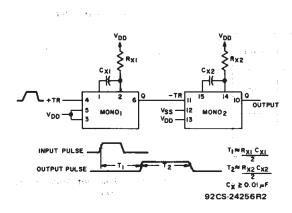


Fig. 15 - Pulse delay.

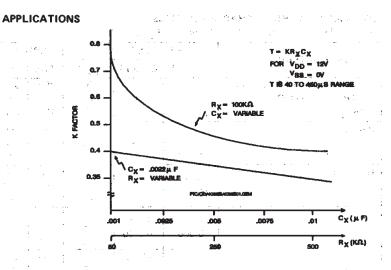


Fig. 17 - K-Factor for $V_{DD} = 12V$.

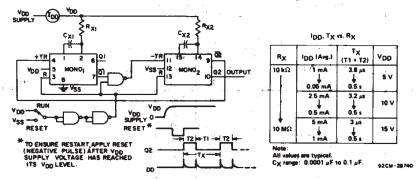
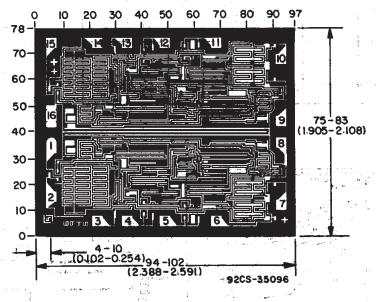


Fig. 16 - Astable multivibrator with restart after reset capability.



Dimensions and Pad Layout for CD4098BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10⁻³ inch).







PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CD4098BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
CD4098BEE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
CD4098BF	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD4098BF3A	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD4098BFB	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD4098BM	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BM96	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BM96E4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BME4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BMT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BMTE4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BPWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4098BPWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
JM38510/17504BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



PACKAGE OPTION ADDENDUM

6-Dec-2006

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2006, Texas Instruments Incorporated